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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/764,938

01/26/2004

Mohammed A. Fathimulla

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11/22/2006

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EXAMINER

PHAM, LONG

HONEYWELL INTERNATIONAL INC.

101 COLUMBIA ROAD

P O BOX 2245

MORRISTOWN, NJ 07962-2245

ART UNIT

PAPER NUMBER

2814

DATE MAILED: 11/22/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/764,938

Applicant(s)

FATHIMULLA ET AL.

Examiner

Long Pham

Art Unit

2814

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 10/16/06.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-6 and 22-35 is/are pending in the application.
- 4a) Of the above claim(s) 22-31 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-6 and 32-35 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413) |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | Paper No(s)/Mail Date. _____ |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Nakagawa et al. (US pat 5,438,220).

With respect to claim 1, Nakagawa et al. teach a semiconductor device comprising (see fig. 18 and associated text):

A high resistivity polysilicon handle wafer or polycrystalline layer 234;

A buried oxide layer 2 located directly on the polysilicon handle wafer; and

A silicon layer 4 located directly on the buried oxide layer.

Claims 3 and 4 are rejected under 35 U.S.C. 102(b) as being anticipated by Nakagawa et al. (US pat 5,438,220).

With respect to claim 1, Nakagawa et al. teach a semiconductor device comprising (see fig. 18 and associated text):

A high resistivity polysilicon handle wafer or polycrystalline layer 234;

A buried oxide layer 2 located directly on the polysilicon handle wafer or polycrystalline layer; and

A silicon layer 4 located directly on the buried oxide layer.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

Art Unit: 2814

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 2, 32, and 33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakagawa et al. (US pat 5,438,220) as applied to claim 1 above, and further in view of the applicant's admitted prior art (AAPA) of this application and Temple et al. (US pat 4,905,075).

With respect to claim 2, Nakagawa et al. teach the wafer having high resistivity or doped polysilicon but fail to teach that the device has an RF input.

AAPA teaches using high resistivity substrate or wafer to form RF device. See the Background of the Invention on pages 1 and 2 of this application.

It would have been obvious to one of ordinary skill in the art of making semiconductor devices to include an RF input on the wafer of Nakagawa et al. to form an RF device having reduced losses and cross-talk. See the background of the Invention on pages 1 and 2 of this application.

With respect claim 32, Nakagawa et al. in combination with AAPA fail to teach that the polysilicon handle wafer has a resistivity of greater than 10^6 ohm-cm.

Temple et al. teach using a polysilicon wafer or handle having a resistivity of greater than 10^6 ohm-cm to provide a structure that can withstand mechanical shock. See col. 2, lines 1-5 and col. 5, lines 20-35.

It would have been obvious to one of ordinary skill in the art of making semiconductor devices to incorporate the teaching of Temple et al. into the structure of Annamalai and AAPA to achieve the above benefit.

With respect to claim 33, AAPA further teaches forming RF component in the silicon layer or wafer to reduce cross-talk.

Claims 5, 6, 34, and 35 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakagawa et al. (US pat 5,438,220) as applied to claims 3 and 4 above, and further in view of the applicant's admitted prior art (AAPA) of this application and Temple et al. (US pat 4,905,075).

With respect to claim 5, Nakagawa et al. teach the wafer having high resistivity or undoped polysilicon but fail to teach that the device has an RF input.

AAPA teaches using high resistivity substrate or wafer to form RF device. See the Background of the Invention on pages 1 and 2 of this application.

It would have been obvious to one of ordinary skill in the art of making semiconductor devices to include an RF input on the wafer of Nakagawa et al. to form an RF device having reduced losses and cross-talk. See the background of the Invention on pages 1 and 2 of this application.

With respect to claim 6, Nakagawa et al. further teach the wafer is made of polysilicon or polycrystalline.

With respect claim 34, Nakagawa et al. in combination with AAPA fail to teach that the polysilicon handle wafer has a resistivity of greater than 10^6 ohm-cm.

Temple et al. teach using a polysilicon wafer or handle having a resistivity of greater than 10^6 ohm-cm to provide a structure that can withstand mechanical shock. See col. 2, lines 1-5 and col. 5, lines 20-35.

It would have been obvious to one of ordinary skill in the art of making semiconductor devices to incorporate the teaching of Temple et al. into the structure of Annamalai and AAPA to achieve the above benefit.

With respect to claim 35, AAPA further teaches forming RF component in the silicon layer or wafer to reduce cross-talk.

Art Unit: 2814

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Long Pham whose telephone number is 571-272-1714. The examiner can normally be reached on Mon-Frid, 10am to 5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 571-272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Long Pham

Primary Examiner

Art Unit 2814

LP

Application/Control Number: 10/764,938

Page 6

Art Unit: 2814